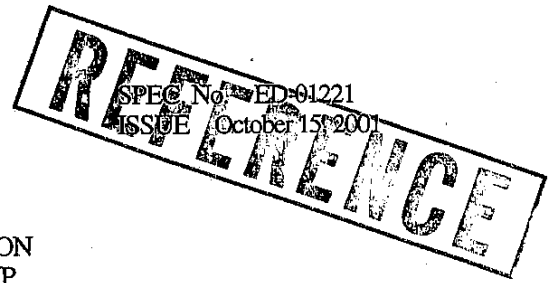


# SHARP

OPTO-ELECTRONIC DEVICES DIVISION  
ELECTRONIC COMPONENTS GROUP  
SHARP CORPORATION

## SPECIFICATION



DEVICE SPECIFICATION FOR

Infrared Detecting unit for Remote Control

MODEL No.

GP1UD28RK series

Specified for :

Enclosed please find copies of the Specifications which consists of 11 pages including cover.  
After confirmation of the contents, please be sure to send back ☐ copies of the Specifications  
with approving signature on each.

CUSTOMER'S APPROVAL

DATE

\_\_\_\_\_

BY

\_\_\_\_\_

PRESENTED

DATE

\_\_\_\_\_

BY

O. Ichikawa,  
Department General Manager of  
Engineering Dept., III  
Opto-Electronic Devices Div.  
ELECOM Group  
SHARP CORPORATION

REFERENCE

Product name : Infrared Detecting unit for Remote Control

Model No. : GP1UD28RK series

1. These specification sheets include materials protected under copyright of Sharp Corporation ("Sharp"). Please do not reproduce or cause anyone to reproduce them without Sharp's consent.
2. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets, as well as the precautions mentioned below. Sharp assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets, and the precautions mentioned below.

(Precautions)

- (1) This product is designed for use in the following application areas ;  
  - OA equipment   · Audio visual equipment   · Home appliances
  - Telecommunication equipment (Terminal)

    If the use of the product in the above application areas is for equipment listed in paragraphs (2) or (3), please be sure to observe the precautions given in those respective paragraphs.
- (2) Appropriate measures, such as fail-safe design and redundant design considering the safety design of the overall system and equipment, should be taken to ensure reliability and safety when this product is used for equipment which demands high reliability and safety in function and precision, such as ;  
  - Transportation control and safety equipment (aircraft, train, automobile etc.)
  - Traffic signals   · Gas leakage sensor breakers   · Rescue and security equipment
  - Other safety equipment
- (3) Please do not use this product for equipment which require extremely high reliability and safety in function and precision, such as ;  
  - Space equipment   · Telecommunication equipment (for trunk lines)
  - Nuclear power control equipment   · Medical equipment
- (4) Please contact and consult with a Sharp sales representative if there are any questions regarding interpretation of the above three paragraphs.

3. Please contact and consult with a Sharp sales representative for any questions about this product.

REFERENCE

## 1. Application

This specifications applies to the model marked "O" in the following models of infrared detecting unit for remote control.

The model list of GP1UD28RK series

Application	Model No.	B.P.F center frequency (TYP)
	GP1UD28RK	40 kHz
	GP1UD280RK	36 kHz
	GP1UD281RK	38 kHz
	GP1UD282RK	36.7 kHz
	GP1UD283RK	32.75 kHz
	GP1UD287RK	56.8 kHz

Main application : TV set, VCR, Radio cassette recorder, Stereo

## 2. Outline

Refer to the attached sheet, Page 7.

## 3. Ratings and characteristics

Refer to the attached sheet, Page 4 to 6.

## 4. Reliability

Refer to the attached sheet, Page 8.

## 5. Outgoing inspection

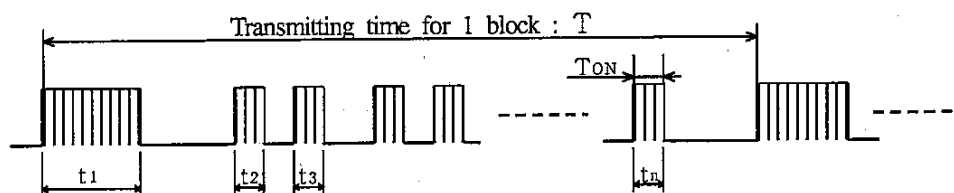
Refer to the attached sheet, Page 9.

## 6. Supplement

- 1) This infrared detecting unit for remote control satisfies each performance requirements in para. 3.5, in the standard optical system in Fig.2.
- 2) This product is built-in photodiode.
- 3) Production place indication of overseas production shall follow the indication in the drawing of the outline dimensions.
- 4) Product mass : Approx. 1.0g
- 5) This product shall not contain the following materials.  
Also, the following materials shall not be used in the production process for this product.  
Materials for ODS : CFCs, Halon, Carbon tetrachloride 1.1.1-Trichloroethane (Methylchloroform)
- 6) Brominated flame retardants  
Specific brominated flame retardants such as the PBBOs and PBBs are not used in this device at all.
- 7) Package specification : Refer to the attached sheet, Page 10.

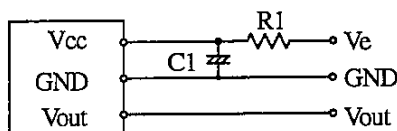
## 7. Notes

- 1) When this infrared remote control detecting unit shall be adopted for wireless remote control, please use it with the signal format of transmitter, which total duty ratio  $D_t$  (Emitting time  $\sum_{N=1}^n t_N$  / Transmitting time for 1 block  $T$ ) is 40% or less. ON signal time  $T_{ON}$  (Pulse width of the presence of modulated IR) should be 250  $\mu$ s or more.  
In case that the signal format of total duty and ON signal time is out of above conditions, there is a case that reception distance is much reduced or output is not appeared.



$$D_t = \left( \sum_{N=1}^n t_N / T \right) \times 100 (\%)$$

- 2) Please use a light emitting unit (remote control transmitter) taking into consideration such factors as the performances, characteristics and operating condition of the light emitting element and the characteristics of this light detecting unit.
- 3) If the surface of detector is smeared with dust or dirt, it may cause faulty operation.  
Caution shall be taken to avoid this. And do not touch the detector surface.  
If the surface was smeared, wipe it clean with soft cloth. If any solvent is needed, Methyl alcohol, Ethyl alcohol, or Isopropyl alcohol should be used. Please don't carry out washing.  
Because, after washing the remainder in solvent or flux in this device cause malfunction.  
Marking on this device is defaced by washing.
- 4) The shield case shall be grounded on the PCB pattern.  
(There are two cases that shield case and GND pin are connected in the shield case, or are not connected in it.)
- 5) It shall not be applied the terminal and case with unnecessary stress.
- 6) Please don't push the detecting side (photodiode) from external.
- 7) In order to prevent electrostatic discharge of integrated circuit, human body and soldering iron, etc. shall be grounded.
- 8) The holes and the slits on the infrared detecting unit shall not be used as the other purpose to maintain its performance.
- 9) When mounting, please mount the external circuit below. (CR filter)  
(External parts should be mounted as close as possible to the sensor.)



(Circuit fixed number)

$R1=47\Omega \pm 5\%$

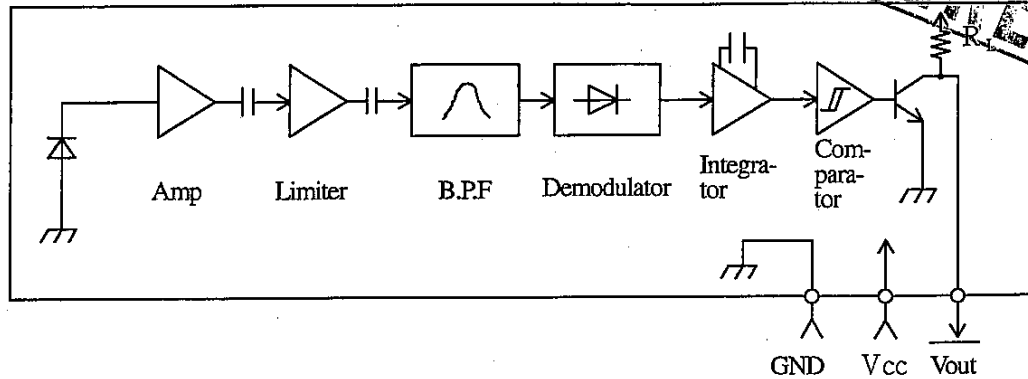
$C1=47\mu F$

The circuit constant is a example. It is difference from mounting equipment. Please select it by your mounting equipment.

- 10) There is a possibility that noise on output may be caused by environmental condition (Disturbing light noise, Electromagnetic noise, Power supply line noise, etc.) even if there is no input transmission signal.
- 11) Please shall confirm operation or your actual machine. Because the output pulse width of this product is fluctuated by environmental conditions such as signal format, temperature, distance from transmitter, and so on.
- 12) In case that this product is kept in high humidity condition, it may be hard to solder, please be careful enough about storage method.  
Depend on the flux you select, there are different solderabilities, so please select a suitable flux and use it.
- 13) Please use this devise away from the dew drop.  
Be aware that the dew drop rusts shield case and others, may affect the electric characteristics.

## 3. Ratings and characteristics

## 3.1 Schematic

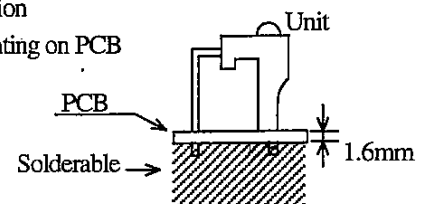


## 3.2 Absolute maximum ratings

Parameter	Symbol	Ratings	Unit
Supply voltage	Vcc	0 to 6.0	V
Operating temperature	Topr	-10 to +70 ※1	°C
Storage temperature	Tstg	-20 to +70	°C
Soldering temperature	Tsol	260 (Soldering time : 5s) ※2	°C

※1) No dew formation

※2) 1.6mm at mounting on PCB



## 3.3 Recommended operating conditions

Parameter	Symbol	Operating condition	Unit
Supply voltage	Vcc	2.7 to 5.5	V

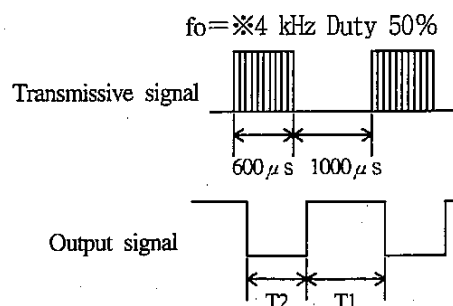
## 3.4 Electrical characteristics

(Unspecified Ta=25°C, Vcc=+5V)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit	Remark
Current dissipation	Icc	-	-	200	μA	No input light
High level output voltage	V <sub>OH</sub>	Vcc-0.5	-	-	V	※3
Low level output voltage	V <sub>OL</sub>	-	-	0.5	V	※3 I <sub>OL</sub> =100 μA
High level pulse width	T <sub>1</sub>	700	-	1200	μs	※3
Low level pulse width	T <sub>2</sub>	400	-	900	μs	※3
B.P.F. center frequency	f <sub>0</sub>	-	※4	-	kHz	

※3) The burst wave as shown in the figure on the right shall be transmitted by the transmitter shown in Fig.1. However, the carrier frequency of transmitter is same as ※4.

Measuring shall be from just after starting the transmission until 50 pulse.



※4) B.P.F. center frequency:  $f_0$  of each model is shown in the list below.

Model No.	B.P.F. center frequency (TYP)	
GPIUD28RK	40	kHz
GPIUD280RK	36	kHz
GPIUD281RK	38	kHz
GPIUD282RK	36.7	kHz
GPIUD283RK	32.75	kHz
GPIUD287RK	56.8	kHz

**REFERENCE**

### 3.5 Performance

The output signal of this infrared detecting unit shall satisfy the following requirements with the transmitter shown in Fig.1 used in the standard optical system in Fig.2.

#### 3.5.1 Characteristics of linear reception distance

The output signal shall satisfy the electrical characteristic requirements in para. 3.4 at  $L=0.2$  to  $8.0\text{m}$ , (※5)  $E_v < 10\text{lx}$ ,  $\phi = 0^\circ$  in Fig.2.

#### 3.5.2 Characteristics of sensitivity angle reception distance

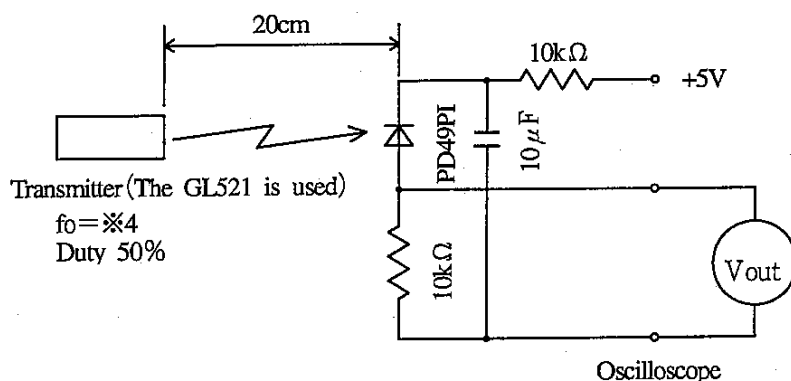
The output signal shall satisfy the electrical characteristic requirements in para. 3.4 at  $L=0.2$  to  $6.0\text{m}$ , (※5)  $E_v < 10\text{lx}$ ,  $\phi \leq 30^\circ$  in Fig.2.

#### 3.5.3 Characteristics of anti-outer peripheral light reception distance

The output signal shall satisfy the electrical characteristic requirements in para. 3.4 at  $L=0.2$  to  $4.0\text{m}$ , (※5, ※6)  $E_v \leq 300\text{lx}$ ,  $\phi = 0^\circ$  in Fig.2.

※5) It refers to detector face illuminance.

※6) Outer peripheral light source: CIE standard light source A shall be used and placed at  $45^\circ$  from the perpendicular axis at the detector face center.

**REFERENCE**

In the figure above, the transmitter shall be set as the output  $V_{out}(p-p)$  will be 40mV.

Note that the PD49PI in this application is the one with short-circuit current

$I_{sc} = 2.6 \mu A$  measured at  $E_v = 100lx$ . ( $E_v$  is the illuminance by CIE standard light source A (tungsten lamp)).

Fig. 1 Transmitter

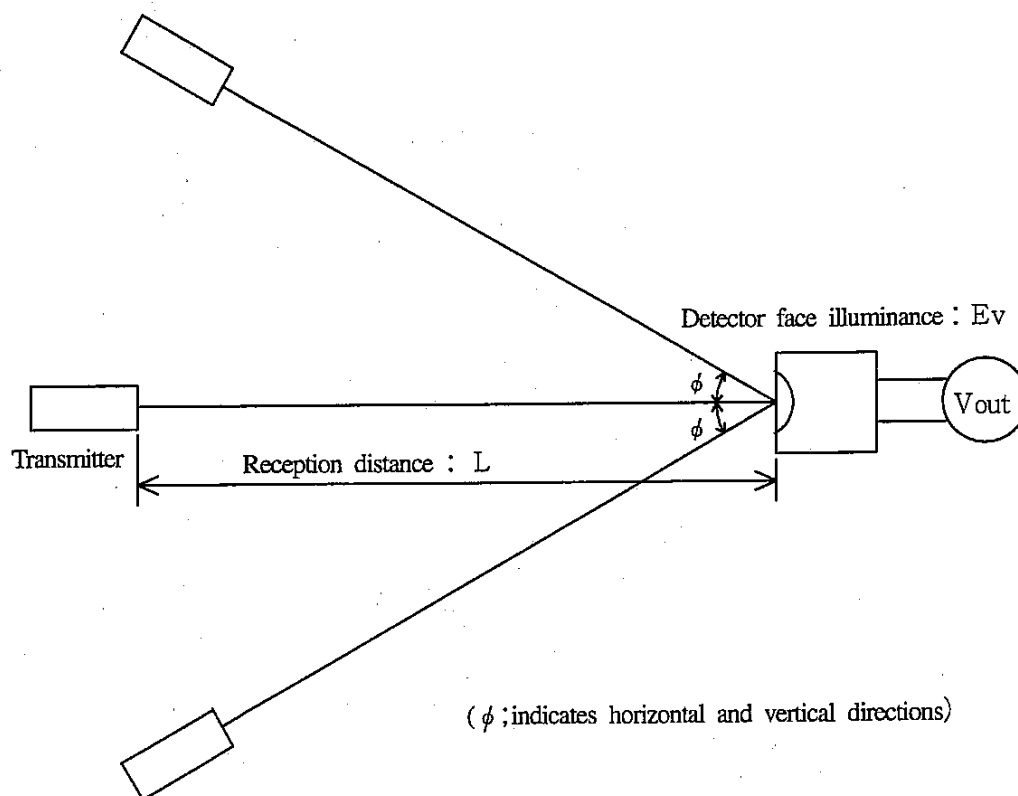


Fig.2 Standard optical system

October 15, 2001

**REFERENCE**

\* Stamp  \* Stamp (Black)

Model name

2144

Week (1 to 6)

Month (1 to Z)

## Stamp list

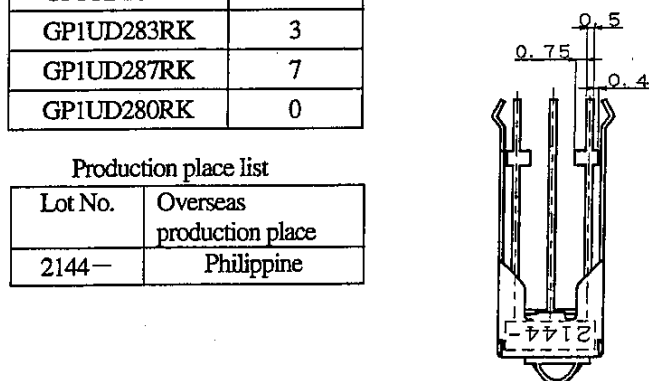
Model No.	Stamp
GP1UD28RK	Without
GP1UD281RK	1
GP1UD282RK	2
GP1UD283RK	3
GP1UD287RK	7
GP1UD280RK	0

### Production place list

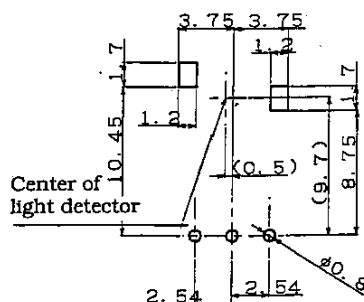
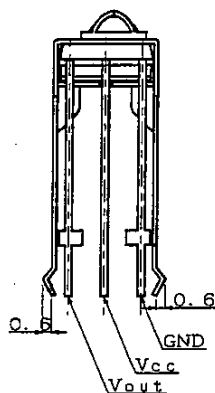
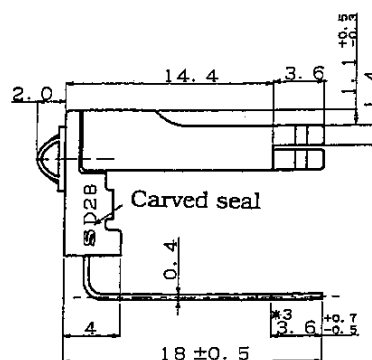
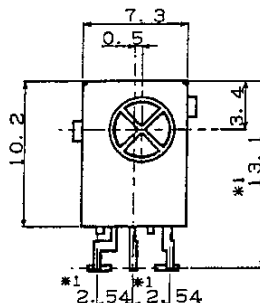
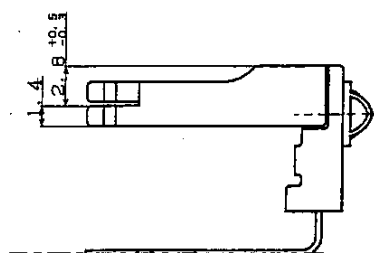
Lot No.	Overseas production place
2144—	Philippine

\* Carved seal

**S D 28** Model No.  
GPIUD28RK series  
Sharp mark



The “-” mark inside ○ shows overseas production place. (\*2)



1. \*1 indicates root dimensions of connector
2. Unspecified tolerance :  $\pm 0.3$
3. Case thickness : 0.3TYP.
4. Case material : Fe
5. Case finish : Solder plating (Pb10%)
6. Lead material : Fe (Ag plating)
7. Lead edge finish : Solder plating or solder dip
8. Mold resin : Epoxy resin
9. Product mass : Approx. 1.0g
10. Dimensions in parenthesis are shown for reference.
11. \*2: Indication “-” mark next to the lot number of “week” mark shows overseas production. (production country is referred to the indication of overseas production place list.)
12. \*3: Exclude sagged solder

Example of mounting  
drawing from solder side  
(Reference)

Scale	Name	GP1UD28RK series Outline Dimensions
2/1		
Unit	Drawing No.	RUD1471
1=1/1mm		



## 4. Reliability

The reliability of products shall satisfy items listed below.

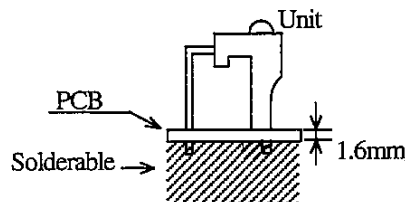
Confidence level 90%  
LTPD : 10%/20%

Test Items	Test Conditions	Failure Judgement Criteria	Samples (n) Defective (C)
Terminal strength (Tension)	Weight : 5N 30s/each terminal	Performance test in para. 3.5 should not be satisfied.	n=11, C=0
Terminal strength (Bending)	Weight : 2.5N 0° -90° -0° 2 times/each terminal		n=11, C=0
Shock	Acceleration: 1000m/s <sup>2</sup> , 6ms 3 directions/3 times		n=11, C=0
Variable frequency vibration	Frequency range: 10 to 55Hz/sweep 1min Overall amplitude: 1.5mm X, Y, Z/2h each		n=11, C=0
* High temp. and high humidity storage	Ta=40°C, 90%RH, t=240h		n=22, C=0
* High temp. storage	Ta=70°C, t=240h		n=22, C=0
* Low temp. storage	Ta=-20°C, t=240h		n=22, C=0
* Temperature cycling	1cycle -20°C to +70°C (30min) (30min) 20 cycles test		n=22, C=0
* Operation life (High temperature)	Ta=70°C, Vcc=3V, t=240h		n=22, C=0
Solder heat	260±5°C, 5s Solder dip (1.6mm at mounting on single-sided PCB) 350±5°C, 3s Soldering by hand (1.6mm at mounting on single-sided PCB)		n=11, C=0 n=11, C=0

In the test \*mark above, the sample to be tested shall be left at normal temperature and humidity for 2hours after it is taken out of the chamber. (No dew drop)

Solder heat tests the unit which is soldered such as Fig.3.

Fig.3



**REFERENCE**

## 5. Outgoing inspection

## (1) Inspection lot

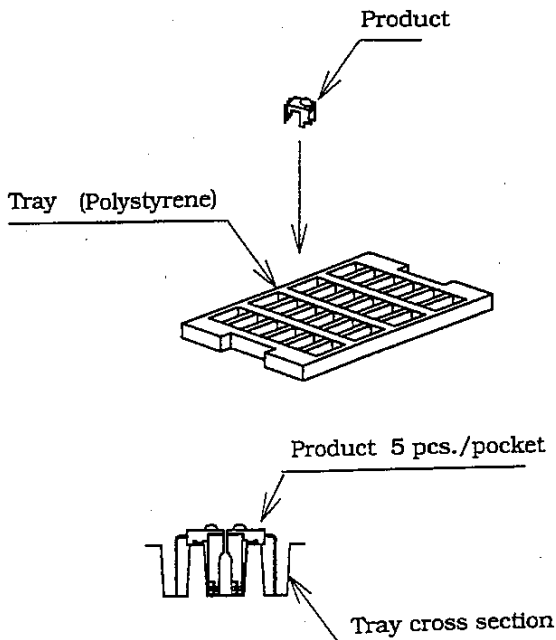
Inspection shall be carried out per each delivery lot.

## (2) Inspection method

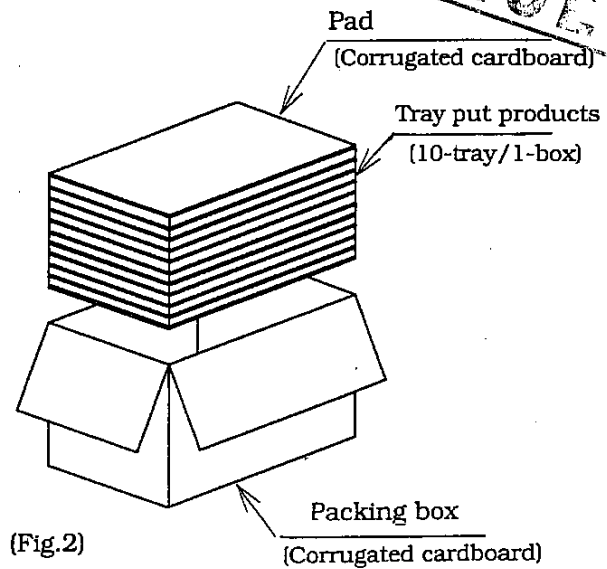
A single sampling plan, normal inspection level II based on ISO 2859 shall be applied.

Classification of Defects		Inspection Items	AQL (%)
Major defect	1	Electrical characteristic defect of $V_{OH}$ , $V_{OL}$ , $T_1$ and $T_2$ in para. 3.4.	0.4
	2	Distance between signal terminal and shield case (0.2mm or more) (Except for GND terminal)	
	3	It should have no remarkable stains and cracks that give any influence of electrical characteristic on light detecting face.	
Minor defect	1	Transformation of shield case (Satisfying outline dimensions of item 2)	1.5
	2	Stamp, Carved seal (It should be possible to read stamp and carved seal of item 2. Stamp and carved seal should be indicated at fixed position.)	

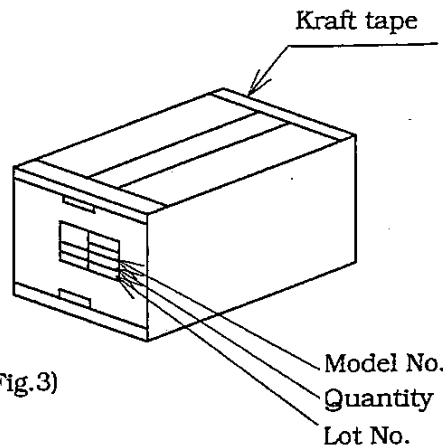
## Package drawings

**REFERENCE**

(Fig. 1)



(Fig. 2)



(Fig. 3)

## Packaging method

- Put products of 200pcs. in tray.  
Put direction is showed in the above fig. (Fig. 1)
  - Put them (10-tray) in the packing box.  
Put pads on their top and bottom, between pads. (Fig. 2)
  - Seal the packing box with kraft tape.  
Print the model No., quantity, and Lot No.  
(2000 pcs./a packing box) (Fig. 3)
- Product mass at 2000pcs./package :  
Approximately 3.23kg

Scale	Name	GP1UD28RK series Package specification
/		
Unit	Drawing No.	RUD1472
1= / mm		

**SPECIFICATIONS ARE SUBJECT TO CHANGE WITHOUT NOTICE.**

Suggested applications (if any) are for standard use; See Important Restrictions for limitations on special applications. See Limited Warranty for SHARP's product warranty. The Limited Warranty is in lieu, and exclusive of, all other warranties, express or implied. ALL EXPRESS AND IMPLIED WARRANTIES, INCLUDING THE WARRANTIES OF MERCHANTABILITY, FITNESS FOR USE AND FITNESS FOR A PARTICULAR PURPOSE, ARE SPECIFICALLY EXCLUDED. In no event will SHARP be liable, or in any way responsible, for any incidental or consequential economic or property damage.

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**NORTH AMERICA**

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SHARP Microelectronics of the Americas  
5700 NW Pacific Rim Blvd.  
Camas, WA 98607, U.S.A.  
Phone: (1) 360-834-2500  
Fax: (1) 360-834-8903  
Fast Info: (1) 800-833-9437  
[www.sharpsma.com](http://www.sharpsma.com)

**EUROPE**

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SHARP Microelectronics Europe  
Division of Sharp Electronics (Europe) GmbH  
Sonninstrasse 3  
20097 Hamburg, Germany  
Phone: (49) 40-2376-2286  
Fax: (49) 40-2376-2232  
[www.sharpsme.com](http://www.sharpsme.com)

**JAPAN**

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SHARP Corporation  
Electronic Components & Devices  
22-22 Nagaike-cho, Abeno-Ku  
Osaka 545-8522, Japan  
Phone: (81) 6-6621-1221  
Fax: (81) 6117-725300/6117-725301  
[www.sharp-world.com](http://www.sharp-world.com)

**TAIWAN**

---

SHARP Electronic Components  
(Taiwan) Corporation  
8F-A, No. 16, Sec. 4, Nanking E. Rd.  
Taipei, Taiwan, Republic of China  
Phone: (886) 2-2577-7341  
Fax: (886) 2-2577-7326/2-2577-7328

**SINGAPORE**

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SHARP Electronics (Singapore) PTE., Ltd.  
438A, Alexandra Road, #05-01/02  
Alexandra Technopark,  
Singapore 119967  
Phone: (65) 271-3566  
Fax: (65) 271-3855

**KOREA**

---

SHARP Electronic Components  
(Korea) Corporation  
RM 501 Geosung B/D, 541  
Dohwa-dong, Mapo-ku  
Seoul 121-701, Korea  
Phone: (82) 2-711-5813 ~ 8  
Fax: (82) 2-711-5819

**CHINA**

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SHARP Microelectronics of China  
(Shanghai) Co., Ltd.  
28 Xin Jin Qiao Road King Tower 16F  
Pudong Shanghai, 201206 P.R. China  
Phone: (86) 21-5854-7710/21-5834-6056  
Fax: (86) 21-5854-4340/21-5834-6057

**Head Office:**

No. 360, Bashen Road,  
Xin Development Bldg. 22  
Waigaoqiao Free Trade Zone Shanghai  
200131 P.R. China  
Email: [smc@china.global.sharp.co.jp](mailto:smc@china.global.sharp.co.jp)

**HONG KONG**

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SHARP-ROXY (Hong Kong) Ltd.  
3rd Business Division,  
17/F, Admiralty Centre, Tower 1  
18 Harcourt Road, Hong Kong  
Phone: (852) 28229311  
Fax: (852) 28660779  
[www.sharp.com.hk](http://www.sharp.com.hk)

**Shenzhen Representative Office:**

Room 13B1, Tower C,  
Electronics Science & Technology Building  
Shen Nan Zhong Road  
Shenzhen, P.R. China  
Phone: (86) 755-3273731  
Fax: (86) 755-3273735